

AP2434GN3-HF

Halogen-Free Product



**Advanced Power
Electronics Corp.**

*DUAL N-CHANNEL ENHANCEMENT
MODE POWER MOSFET*

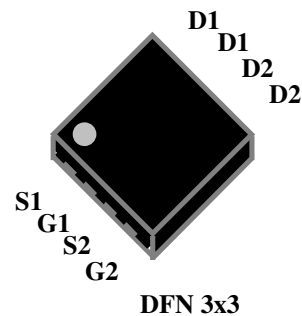
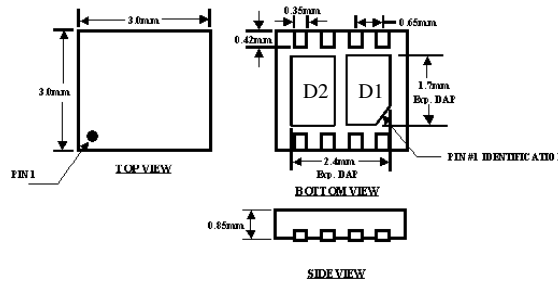
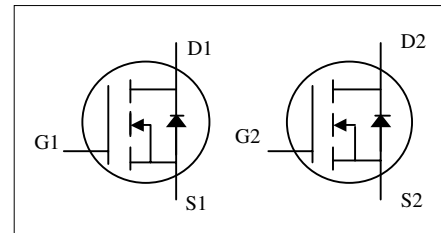
- ▼ Bottom Exposed DFN
- ▼ Low On-resistance
- ▼ Small Size & Lower Profile
- ▼ RoHS Compliant & Halogen-Free

V_{DSS}	30V
$R_{DS(ON)}$	18m Ω
I_D	10.5A

Description

Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The DFN 3x3 package is well suited for low current DC/DC applications.



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	30	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D @ T_A = 25^\circ\text{C}$	Continuous Drain Current ³ , $V_{GS} @ 10\text{V}$	10.5	A
$I_D @ T_A = 70^\circ\text{C}$	Continuous Drain Current ³ , $V_{GS} @ 10\text{V}$	8.4	A
I_{DM}	Pulsed Drain Current ¹	30	A
$P_D @ T_A = 25^\circ\text{C}$	Total Power Dissipation	3.1	W
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ\text{C}$

Thermal Data

Symbol	Parameter	Rating	Units
R_{thj-a}	Maximum Thermal Resistance, Junction-ambient ³	40	$^\circ\text{C}/\text{W}$



AP2434GN3-HF

Electrical Characteristics@T_j=25°C(unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	30	-	-	V
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =10V, I _D =10A	-	-	18	mΩ
		V _{GS} =4.5V, I _D =6A	-	-	26	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250uA	1	-	3	V
g _{fs}	Forward Transconductance	V _{DS} =10V, I _D =11A	-	20	-	S
I _{DSS}	Drain-Source Leakage Current	V _{DS} =24V, V _{GS} =0V	-	-	10	uA
I _{GSS}	Gate-Source Leakage	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA
Q _g	Total Gate Charge	I _D =11A	-	10	16	nC
Q _{gs}	Gate-Source Charge	V _{DS} =15V	-	3	-	nC
Q _{gd}	Gate-Drain ("Miller") Charge	V _{GS} =4.5V	-	4.5	-	nC
t _{d(on)}	Turn-on Delay Time	V _{DS} =15V	-	9	-	ns
t _r	Rise Time	I _D =1A	-	5	-	ns
t _{d(off)}	Turn-off Delay Time	R _G =3.3Ω	-	21	-	ns
t _f	Fall Time	V _{GS} =10V	-	4.5	-	ns
C _{iss}	Input Capacitance	V _{GS} =0V	-	1100	1760	pF
C _{oss}	Output Capacitance	V _{DS} =15V	-	140	-	pF
C _{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	100	-	pF
R _g	Gate Resistance	f=1.0MHz	-	1.3	2.6	Ω

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V _{SD}	Forward On Voltage ²	I _S =10A, V _{GS} =0V	-	-	1.2	V
t _{rr}	Reverse Recovery Time	I _S =11A, V _{GS} =0V,	-	23	-	ns
Q _{rr}	Reverse Recovery Charge	dI/dt=100A/μs	-	16	-	nC

Notes:

- 1.Pulse width limited by Max. junction temperature.
- 2.Pulse test
- 3.Surface mounted on 1 in² copper pad of FR4 board, t ≤5sec ; 100°C/W at steady state.

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

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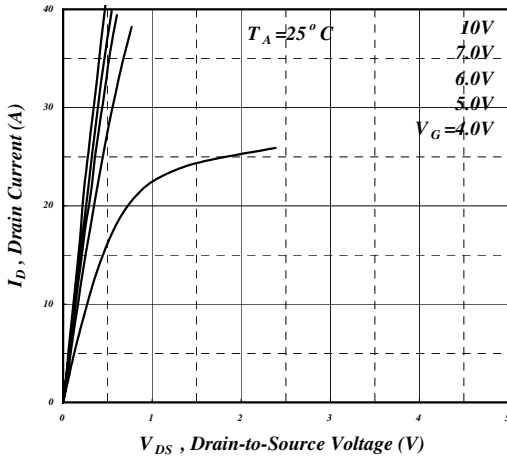


Fig 1. Typical Output Characteristics

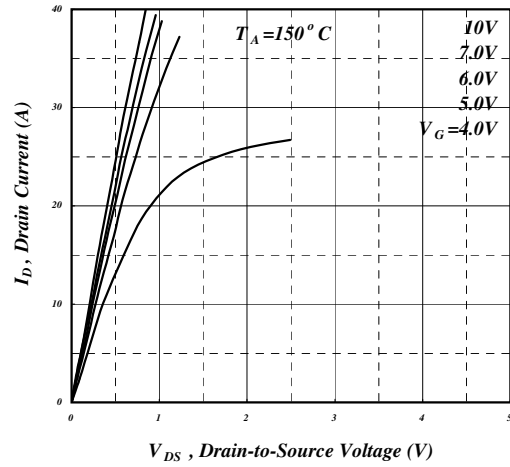


Fig 2. Typical Output Characteristics

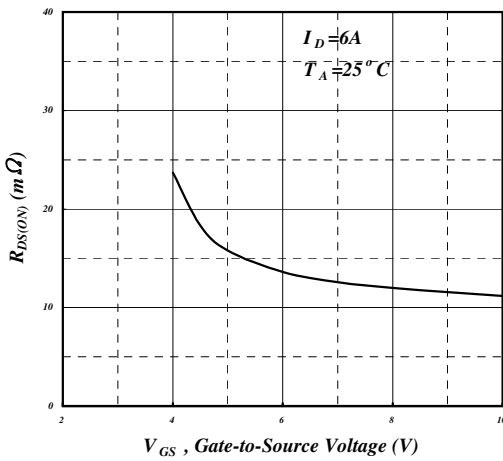


Fig 3. On-Resistance v.s. Gate Voltage

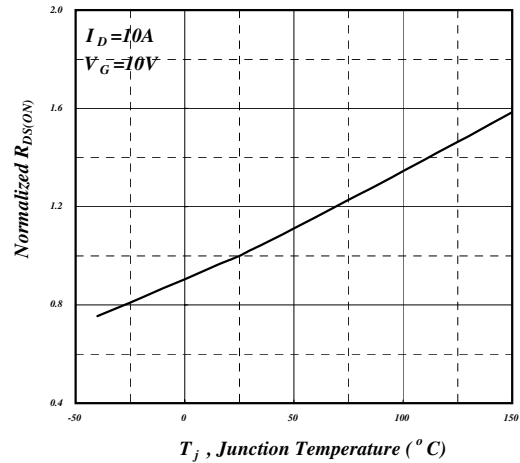


Fig 4. Normalized On-Resistance v.s. Junction Temperature

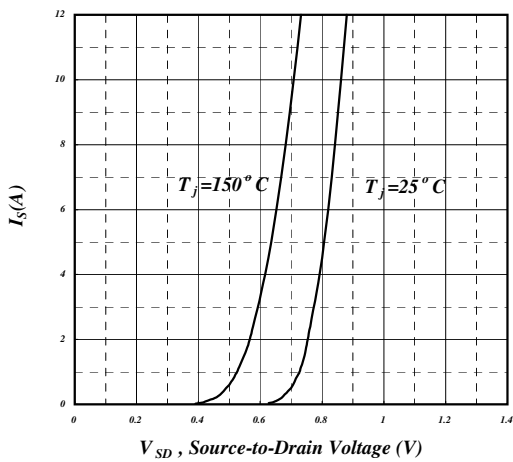


Fig 5. Forward Characteristic of Reverse Diode

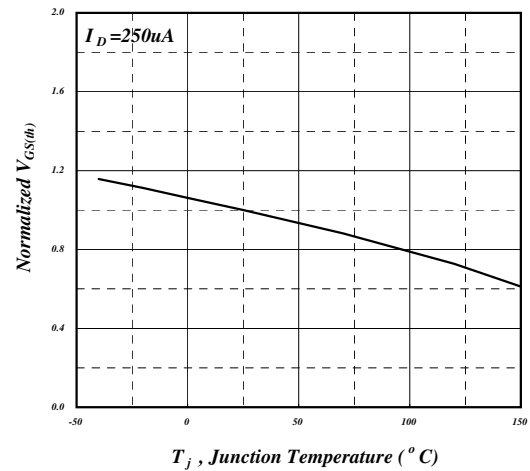


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

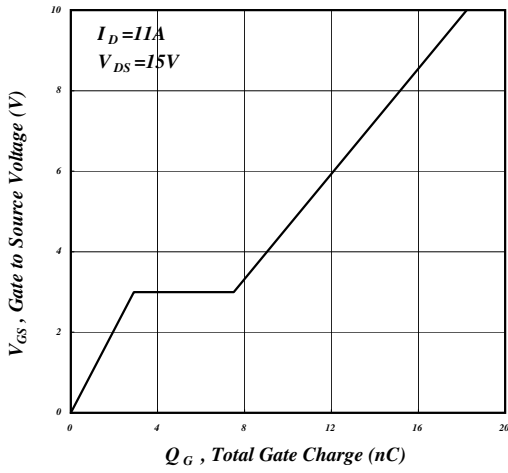


Fig 7. Gate Charge Characteristics

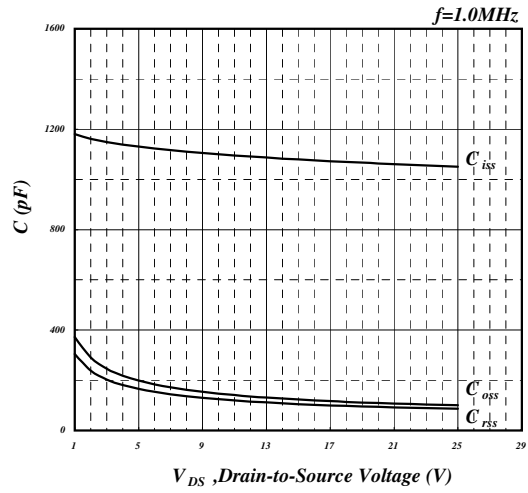


Fig 8. Typical Capacitance Characteristics

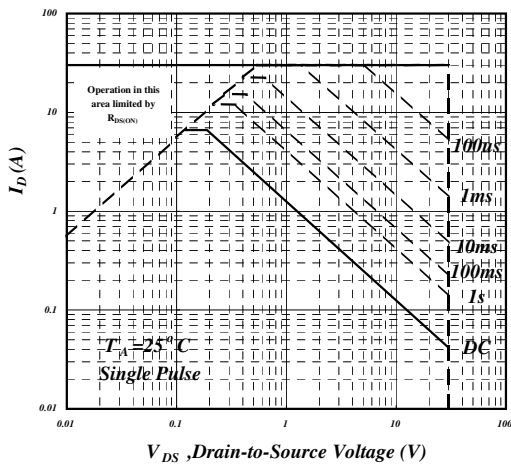


Fig 9. Maximum Safe Operating Area

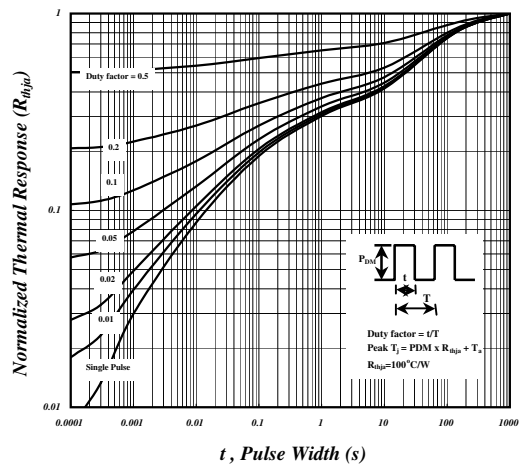


Fig 10. Effective Transient Thermal Impedance

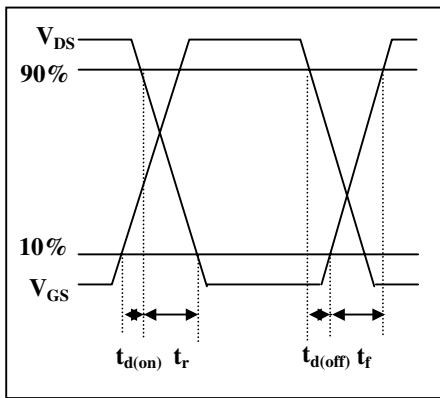


Fig 11. Switching Time Waveform

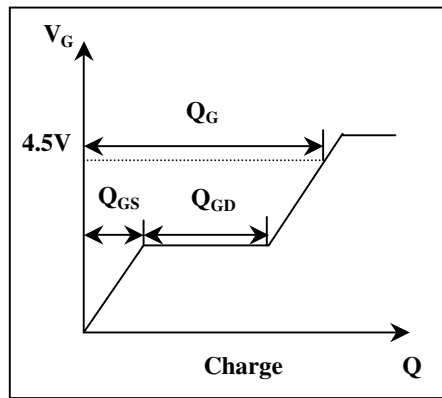


Fig 12. Gate Charge Waveform